



**REQUEST  
FOR  
CONTINUED EXAMINATION (RCE)  
TRANSMITTAL**

Subsection (b) of 35 U.S.C. § 132, effective on May 29, 2000,  
provides for continued examination of an utility or plant application  
filed on or after June 8, 1995.  
See The American Inventors Protection Act of 1999 (AIPA).

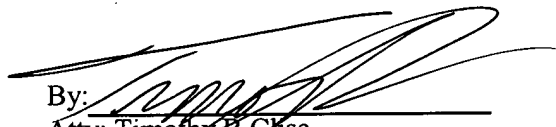
*RCE JZU*

Application Number	10/786,354
Filing Date	February 25, 2004
First Named Inventor	Kie Y. Ahn
Group Art Unit	2818
Examiner Name	Andy Huynh
Attorney Docket Number	303.686US3
Customer No.	21186

This is a Request for Continued Examination (RCE) under 37 CFR § 1.114 of the above-identified application entitled MULTILEVEL COPPER INTERCONNECTS WITH LOW-K DIELECTRICS AND AIR GAPS.

Submission required under 37 C.F.R. § 1.114

1. ☐ Consider the amendment(s)/reply under 37 C.F.R. § 1.116 previously filed on .
2. ☐ Consider the arguments in the Appeal Brief or Reply Brief previously filed on .
3. ☐ Amendment Under 37 CFR § 1.116 ( pages) is enclosed.
4. ☐ New power of attorney ( pages) is enclosed.
5. ☒ Information Disclosure Statement is enclosed (2 pages), with:
  - a. Form 1449 (1 pages)
  - b. Copies of IDS Citations ( )
6. ☐ Check in the amount of 0.00 is attached to pay the RCE filing fee required under C.F.R. § 1.17(e).
7. ☒ **The Commissioner is hereby authorized to charge the required fee of \$790.00 and any fees set forth in 37 CFR §§ 1.16 through 1.18 to Deposit Account No. 19-0743.**
8. ☐ Petition for Extension of Time in the prior application (1 page) is enclosed along with a check in the amount of to pay the extension fee.
9. ☐ Others:  
SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

By:   
Atty: Timothy B Chase  
Reg. No. 40,957

**CERTIFICATE UNDER 37 CFR 1.8:** The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Attn-Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 15 day of September, 2005.

Name



Signature

